

THIS SHEET HAS BEEN
REPLACED

Abstract:

The invention relates to a sawing suspension which is composed of an essentially nonaqueous liquid in which hard-material particles are dispersed. The liquid is selected from a group of compounds which comprises low-molecular-weight polyglycols and any desired mixtures of said compounds. The sawing suspension is used in conjunction with a wire saw for cutting wafers from a crystal of brittle and hard material.

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